PATENT APPLICATION

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NSR/CCD(jjw(wlm/jam/dc) November 2, 2004

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Yi Hua Ma, Ivan P. Mardilovich and Erik E. Engwall

Application No.: 10/804,847

Group Art Unit:

1724

Filed:

Title:

March 19, 2004

Examiner:

Not assigned

DOCKET NO.: 1021.2006-001

Confirmation No.: 7500

METHOD FOR FABRICATING COMPOSITE GAS SEPARATION MODULES

CERTIFICATE	OF MAILING OR TRANSMISSION
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## INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:	
This	s Information Disclosure Statement is submitted: under 37 CFR 1.129(a), or (First/Second submission after Final Rejection)
[X]	under 37 CFR 1.97(b), or (Within any one of the following time periods: three months of filing national application (other than a CPA) or date of entry of the national stage in an international application; or before the mailing date of a first office action on the merits in a non-provisional application, including a CPA, or a Request for Continued Examination).
[ ]	under 37 CFR 1.97(c) together with either:
	[ ] a Statement under 37 CFR 1.97(e), as checked below, or
	[ ] a \$180.00 fee under 37 CFR 1.17(p), or (After the 37 CFR 1.97(b) time period, but before final action or notice of allowance, whichever occurs first)
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[ ]	under 37 CFR 1.97(I): Applicant requests that the IDS and cited reference(s) be placed in the application filewrapper. (Filed after payment of issue fee)

Stater	nent Un	aer 3/C	<u>JFR 1.97(e)</u>				
[ ]	any co	mmuni	nformation contained in this Information Disclosure Statement was first cited in cation from a foreign patent office in a counterpart foreign application not more nths prior to the filing of this Information Disclosure Statement; or				
[]	No item of information contained in this Information Disclosure Statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned, after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in 37 CFR 1.56(c) more than three months prior to the filing of this Information Disclosure Statement.						
Stater	nent Un	der 37 (	CFR 1.704(d) (Patent Term Adjustment) Applies to original applications (other than design) filed on or after May 29, 2000				
[]	comm was no	unication traceive	information contained in the Information Disclosure Statement was cited in a on from a foreign patent office in a counterpart application and this communication wed by any individual designated in § 1.56(c) more than thirty days prior to the aformation Disclosure Statement.				
[X]	Enclos	sed here	ewith is form PTO-1449:				
LJ							
	[X]	•	s of the cited references (AL-AQ, AR-AZ and AR2) are enclosed.				
		[X]	Since this application was filed after June 30, 2003, copies of issued U.S. patents and published U.S. applications are not required and are not being provided.				
	[]	Appli	s of the cited references are enclosed except those entered in prior application, U.S. cation No. [ ], to which priority under 35 U.S.C. 120 is claimed. [The earlier ation contains copies of the cited references.]				
	[X]	The li Intern	sted references (AB, AE, AH, AE3 and AL-AP) were cited in the enclosed ational Search Report in a counterpart foreign application.				
	[X]	The "cand A	concise explanation" requirement (non-English references) for references AM, AP Q under 37 CFR 1.98(a)(3) is satisfied by:				
		[]	the explanation provided on the attached sheet.				
		[ ]	the explanation provided in the Specification.				
		[X]	submission of the enclosed International Search Report for references AM and AP.				
		[ ]	submission of the enclosed English-language version of a foreign Search Report and/or foreign Office Action.				
		[X]	the enclosed English language abstract for reference AO.				

[ X ]	Applic	cant requests that the followir	ng non-published pending applications be considered:
Examiner's Initials			
			. 10/804,846 by Yi Hua Ma, Ivan P. Mardilovich and Erik E. 004, Docket No.: 1021.2005-001.
			. 10/804,848 by Yi Hua Ma, Ivan P. Mardilovich and Erik E. 004, Docket No.: 1021.2004-001.
			. 10/836,088 by Yi Hua Ma, Ivan P. Mardilovich and Erik E. 04, Docket No.: 1021.2007-001.
		Examiner	Date
	[X]	A copy of each above-cited	application, including the current claims, is enclosed.
	[]	A copy of each above-cited those entered in prior applicable 35 U.S.C. 120 is claimed.	application, including the current claims, is enclosed, except cation, U.S. Application No. [ ], to which priority under
The E	xamine nces we	r is requested to return a copy re considered with the next o	of the above list of pending applications indicating which ffice communication.
It is re	quested	I that the information disclose	ed herein be made of record in this application.
Metho	od of pa	yment:	
[]		ck for the fee noted above is a panying Reply. A copy of the	enclosed, or the fee has been included in the check with the is Statement is enclosed.
[]	Please enclos	e charge Deposit Account 08- sed.	0380 in the amount of \$[ ]. A copy of this Statement is
[X]	Please	e charge any deficiency in fee	s and credit any overpayment to Deposit Account 08-0380.
			Respectfully submitted,
			HAMILTON, BROOK, SMITH & REYNOLDS, P.C.
			By Colin C. Durham Registration No.: 52,843 Telephone: (978) 341-0036 Facsimile: (978) 341-0136

Concord, MA 01742-9133 Dated: 11/2/04

PTO:1449 REPRODUCED	ATTORNEY DOCKET NO. 1021.2006-001	l i	PLICATION NO. /804,847	Sheet 1 of
INFORMATION DISCLOSURE CITATION O 1 5 2004 November 2, 2004	FIRST NAMED INVENTOR Yi Hua Ma		FILING DATE March 19, 2	2004
November 2, 2004  (Use several sheets if necessary)	EXAMINER N/A	CONF 7500	IRMATION NO.	GROUP 1724

		U.:	S. PATENT DOCUMENTS	
EXAM- INER INI- TIAL	REF. DOCUMENT NUMBER NO. Number-Kind Code (if known)		ISSUE DATE / PUBLICATION DATE MM-DD-YYYY	NAME OF PATENTEE OR APPLICANT OF CITED DOCUMENT
	AA	2,958,391	11-01-1960	deRosset
•	AB	3,241,298	03-22-1966	Pierce
	AC	3,413,777	12-03-1968	Langley, et al.
	AD	3,428,476	02-18-1969	Langley, et al.
	AE	3,717,525	02-20-1973	Bültemann
	AF	4,496,373	01-29-1985	Behr, et al.
	AG	4,589,891	05-20-1986	Iniotakis, et al.
	AH	4,689,150	08-25-1987	Abe, et al.
	Al	5,049,167	09-17-1991	Castro, et al.
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	AK	5,205,841	04-27-1993	Vaiman
	AA2	5,215,729	06-01-1993	Buxbaum
	AB2	5,217,506	06-08-1993	Edlund, et al.
	AC2	5,258,339	11-02-1993	Ma, et al.
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	AF2	5,393,325	02-28-1995	Edlund
	AG2	5,451,386	09-19-1995	Collins, et al.
	AH2	5,449,848	09-12-1995	Itoh
	AI2	5,498,278	03-12-1996	Edlund
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	AK2	5,652,020	07-29-1997	Collins, et al.
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	AC3	5,782,959	07-21-1998	Yang, et al.
•	AD3	5,782,960	06-21-1998	Ogawa, et al.

EXAMINER	DATE CONSIDERED

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IN AN APPLICATION	FIRST NAMED INVENTOR Yi Hua Ma  FILING DATE March 19, 2		2004		
November 2, 2004  (Use several sheets if necessary)	EXAMINER N/A	CONF1	RMATION NO.	GROUP 1724	

		U.S	. PATENT DOCUMENTS	
))		DOCUMENT NUMBER Number-Kind Code (if known)	ISSUE DATE / PUBLICATION DATE MM-DD-YYYY	NAME OF PATENTEE OR APPLICANT OF CITED DOCUMENT
	AE3	5,895,769	04-20-1999	Lai
•	AF3	5,904,754	05-18-1999	Juda, et al.
	AG3	6,086,729	07-11-2000	Bredesen, et al.
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	AA4	6,372,363	06-16-2002	Krueger
	AB4	6,379,524 B1	04-30-2002	Lee, et al.
	AC4	6,419,728	06-12-2002	Edlund
	AD4	6,475,268	11-05-2002	Thornton
	AE4	6,547,858	04-15-2003	Edlund, et al.
	AF4	6,596,057	07-22-2003	Edlund, et al.
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EXAMINER	DATE CONSIDERED	

PTO-1449 REPRODUCED  INFORMATION DISCLOSURE CITATION	ATTORNEY DOCKET NO. 1021.2006-001 APPLICATION NO. 10/804,847			
IN AN APPLICATION	FIRST NAMED INVENTOR Yi Hua Ma FILING DATE March 19, 2		2004	
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		F	OREIGN PATENT D	OCUMENTS	
		DOCUMENT NUMBER Country Code-Number-Kind Code (if known)	DATE MM-DD-YYYY	NAME OF PATENTEE OR APPLICANT OF CITED DOCUMENT	TRANSLATION YES NO
	AL	JP 5085702 (Abstract)	04-06-1993	Mitsubishi Heavy Ind Ltd	X
•	AM	EP 1 180 392 A1	02-20-2002	OMG AG & Co. KG	x
	AN	EP 1 208 904 A1	05-29-2002	Sumitomo Electric Industries, Ltd.	
	AO	EP 1 277 512 A1	01-22-2003	Sumitomo Electric Industries, Ltd.	***
	AP	WO 02/066144 A2	08-29-2002	COMPAGNIE D'ETUDE DES TECHNIQUES DE L'HYDROGENE (CETH)	х
	AQ	WO 03/011433 A1	02-13-2003	Fraunhofer-Gesellschaft zur Förderung der angewandten Forschung e.V.	х
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AR	Gryaznov, V. M., "Metal Containing Membranes for the Production of Ultrapure Hydrogen and the Recovery of Hydrogen Isotopes," <i>Separation and Purification Methods</i> (now <i>Separation and Purification Reviews</i> ), 29(2):171-187 (2000).
AS	Gryaznov, V. M., et al., "Preparation and catalysis over Palladium Composite Membranes," Applied Catalysis A: General, 96:15-23 (1993).
AT	Ma, Y. H., et al., "Characterization of Intermetallic Diffusion Barrier and Alloy Formation for Pd/Cu and Pd/Ag Porous Stainless Steel Composite Membranes," <i>I &amp; EC Research</i> , 43:2936-2945 (2004).
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AX	Ozaki, T., et al., "Preparation of Palladium-coated V and V-15 Ni Membranes for Hydrogen Purification by Electroless Plating Technique," <i>Int. J. Hydrogen Energy</i> , 28:297 (2003).
AY	Roa, F., "Preparation and Characterization of Pd-Cu Composite Membranes for Hydrogen Separation," <i>Chem. Eng. J.</i> , 93:11 (2003).
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